

Features

- Simple Single-Loop Control Design
 - Voltage-Mode PWM Control
- Excellent Output Voltage Regulation
 - PWM Output : $\pm 1\%$ Over Temperature
- Fast Transient Response
 - High-Bandwidth Error Amplifier
 - Full 0% to 100% Duty Ratio
- 3-Bit Digital-to-Analog Output Voltage Selection
- Over-Voltage and Over-Current Fault Monitors
- Small Converter Size
 - 200kHz Free-Running Oscillator
 - Programmable from 50kHz to 800kHz

Applications

- High-Power 5V to 3.3V (or below) DC-DC Regulators
- Low-Voltage Distributed Power Supplies
- VGA Card Power Regulation

General Description

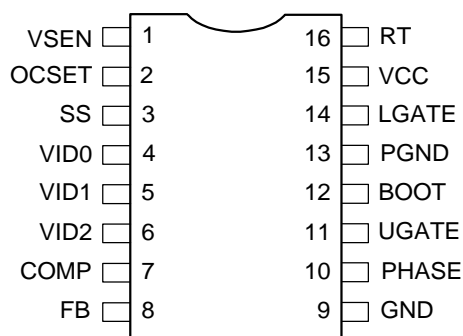
The APW7016 provides a complete control and protection for a DC-DC converter optimized for high performance microprocessor applications. It is designed to drive two N-Channel MOSFETs in a synchronous-rectified buck topology. The APW7016 integrates output voltage control, monitoring and protection functions into a single Package.

The APW7016 includes a 3-bit digital-to-analog converter (DAC) that provides a easily adjustable and precisely output voltage from $1.3V_{DC}$ to $1.65V_{DC}$ in 0.05V steps. Any selected output voltage can be maintained within $\pm 1\%$ accuracy over temperature and line voltage variations.

With a 200kHz free-running triangle-wave oscillator and a error amplifier featuring a 15MHz unity-gain bandwidth and 6V/ μ s slew rate inside the chip, APW7016 can implement a simple, single feedback loop, voltage-mode control topology with high transient performance.

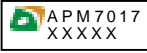
The APW7016 also features with multiple protections against over-current and over-voltage conditions by inhibiting PWM operation. The APW7016 uses the $R_{DS(ON)}$ of the upper MOSFET as the current sensing element which eliminates the demand for an extra component. The APW7016 also monitors the output voltage using a comparator with hysteresis that tracks the DAC output.

Pin Description

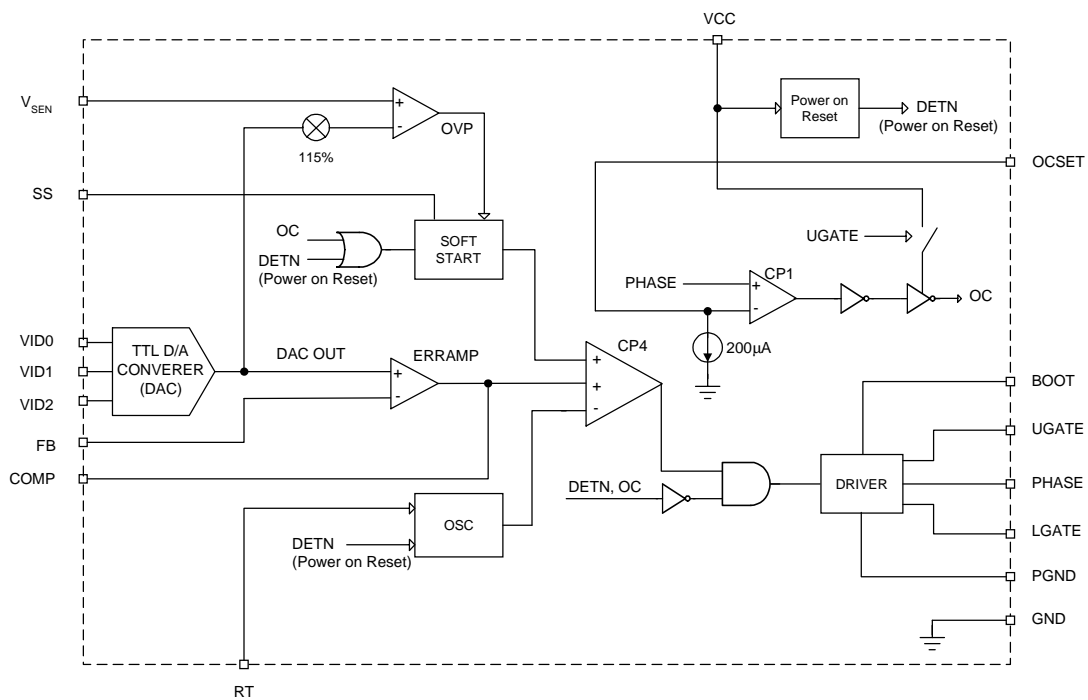


ANPEC reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

Ordering and Marking Information

| | |
|--|---|
| <p>APW7016 □□-□□</p> <p> └─ Handling Code └─ Temp. Range └─ Package Code </p> | <p>Package Code K : SOP - 16 N : SSOP - 16</p> <p>Temp. Range C : 0 to 70 °C</p> <p>Handling Code TU : Tube TR : Tape & Reel</p> |
| <p>APM7016 K/N :  </p> | <p>XXXXX - Date Code</p> |

Block Diagram



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit |
|------------------------|-------------------------------------|-------------------------------|------|
| VCC | Supply Voltage | 15 | V |
| $V_{BOOT} - V_{PHASE}$ | Boot Voltage | 15 | V |
| V_I, V_O | Input, Output or I/O Voltage | GND - 0.3 V to $V_{CC} + 0.3$ | V |
| T_A | Operating Ambient Temperature Range | 0 to 70 | °C |
| T_J | Junction Temperature Range | 0 to 150 | °C |
| T_{STG} | Storage Temperature Range | -65 to +150 | °C |
| T_S | Soldering Temperature | 300, 10 seconds | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|---------------------------------------|-------|-----------------------------|
| $R_{\theta JA}$ | Thermal Resistance in Free Air | | |
| | SOP , SSOP | 110 | $^{\circ}\text{C}/\text{W}$ |
| | SOP (with 3in ² of Copper) | 86 | |

Electrical Characteristics

Recommended operating conditions , unless otherwise noted

| Symbol | Parameter | Test Conditions | APW7016 | | | Unit |
|--------------------------------------|--|---|---------|------|------|------------------|
| | | | Min. | Typ. | Max. | |
| V_{CC} Supply Current | | | | | | |
| I_{CC} | Nominal Supply | UGATE and LGATE open | | 3 | | mA |
| Power-on Reset | | | | | | |
| | Rising V _{CC} Threshold | Vocset=4.5V | | | 10.7 | V |
| | Falling V _{CC} Threshold | Vocset=4.5V | 8.2 | | | V |
| Oscillator | | | | | | |
| | Free Running Frequency | RT= Open | 185 | 200 | 215 | kHz |
| ΔV_{OSC} | Ramp Amplitude | RT= Open | | 2 | | V _{P-P} |
| Reference and DAC | | | | | | |
| | DAC(VID0-VID2) Input Low Voltage | | | | 0.8 | V |
| | DAC(VID0-VID2) Input High Voltage | | | 3.0 | | V |
| | DACOUT Voltage accuracy | | -1.0 | | +1.0 | % |
| Error Amplifier | | | | | | |
| | DC Gain | | | 88 | | dB |
| GBW | Gain-Bandwidth Product | | | 15 | | MHz |
| SR | Slew Rate | COMP=20pF | | 6 | | V/ μs |
| PWM Controller Gate Driver | | | | | | |
| R_{UGATE} | UGATE Source | V _{CC} =12V , V _{UGATE} =6V | 350 | 500 | | mA |
| R_{UGATE} | UGATE Sink | V _{UGATE-PHASE} =1V | | 5.5 | 10 | Ω |
| R_{LGATE} | LGATE Source | V _{CC} =12V , V _{LGATE} =1V | 350 | 450 | | mA |
| R_{LGATE} | LGATE Sink | V _{LGATE} =1V | | 3.5 | 6.5 | Ω |
| Protection | | | | | | |
| | Over-Voltage Trip (V _{SEN} /DACOUT) | | | 115 | 120 | % |
| I_{OCSET} | OCSET Current Source | V _{OCSET} =4.5V _{DC} | 170 | 200 | 230 | μA |
| I_{SS} | Soft Start Current | | | 10 | | μA |

Pin Function Description

VSEN (pin 1)

Connect this pin to the converter's voltage output. The OVP comparator circuits monitor output voltage status and act over voltage protection by using this signal.

OCSET(pin 2)

Connect a resistor(R_{OCSET}) from this pin to the drain of the upper MOSFET. An internal 200 μ A current source (I_{OCS}), R_{OCSET} , and the upper MOSFET's on-resistance ($R_{DS(ON)}$) set the converter over-current (OC) trip point according to the following equation :

$$I_{PEAK} = \frac{I_{OCSET} * R_{OCSET}}{R_{DS(ON)}}$$

An over-current trip resets the soft-start function.

SS (Pin 3)

Connect a capacitor from this pin to ground. This capacitor, along with an internal 10 μ A current source, sets the soft-start interval of the converter.

VID0-2 (Pins 4-6)

VID0-2 are the input pins to the 3-bit DAC. The states of these three pins decide the internal voltage reference (DACOUT). The level of DACOUT sets the converter output voltage and also sets the OVP thresholds. Table 1 specifies DACOUT for the 8 combinations of DAC inputs.

COMP (pin 7) and FB (pin 8)

COMP and FB are the accessible pins of the error amplifier. FB pin is the inverting input of the error amplifier and COMP pin is output of the error amplifier. These pins provide the compensation for the voltage-control feedback loop of the converter.

GND (Pin 9)

GND is signal ground of the IC. All voltage levels are measured with respect to this pin.

PHASE (pin 10)

Connect the PHASE pin to the source of the upper MOSFET. This pin is used to monitor the voltage drop across the upper MOSFET for over-current protection.

UGATE (pin 11)

Connect UGATE to the upper MOSFET gate. This pin enables the gate drive signal to drive the upper MOSFET .

BOOT (pin 12)

BOOT pin provides bias voltage to the upper MOSFET gate driver. A bootstrap circuit could be used to pump a BOOT voltage for enforcing the driving capability of the gate driver and improving the performance of the upper MOSFET.

PGND(pin 13)

PGND pin provides the power ground connection. Connect this pin to the source of the lower MOSFET.

LGATE (pin 14)

Connect LGATE to the lower MOSFET gate. This pin enables the gate drive signal to drive the lower MOSFET.

VCC (pin 15)

Connect VCC to 12V voltage supply. This pin supplies the bias for the chip.

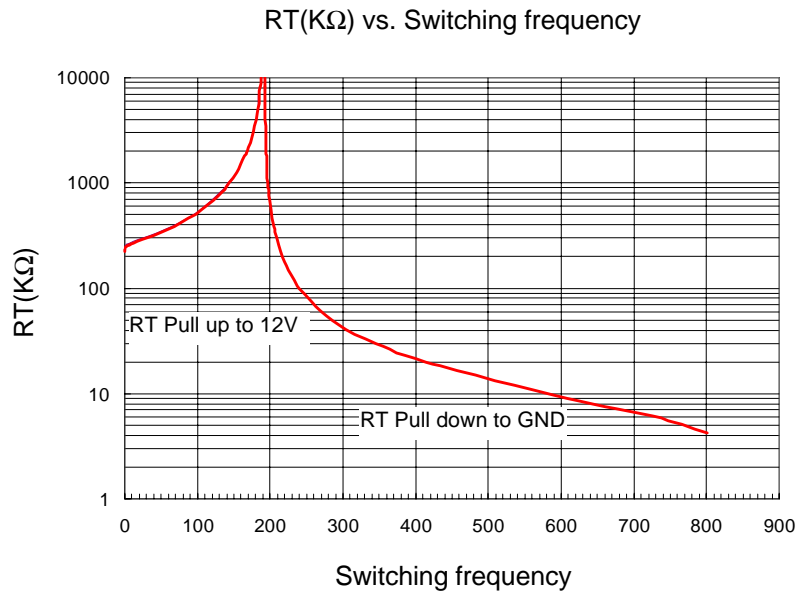
RT (pin 16)

RT pin provides oscillator switching frequency adjustment. By connecting a resistor (R_T) from this pin to GND, the nominal 200kHz switching frequency is increased. Conversely, connecting a pull-up resistor (R_T) from this pin to V_{CC} reduces the switching frequency.

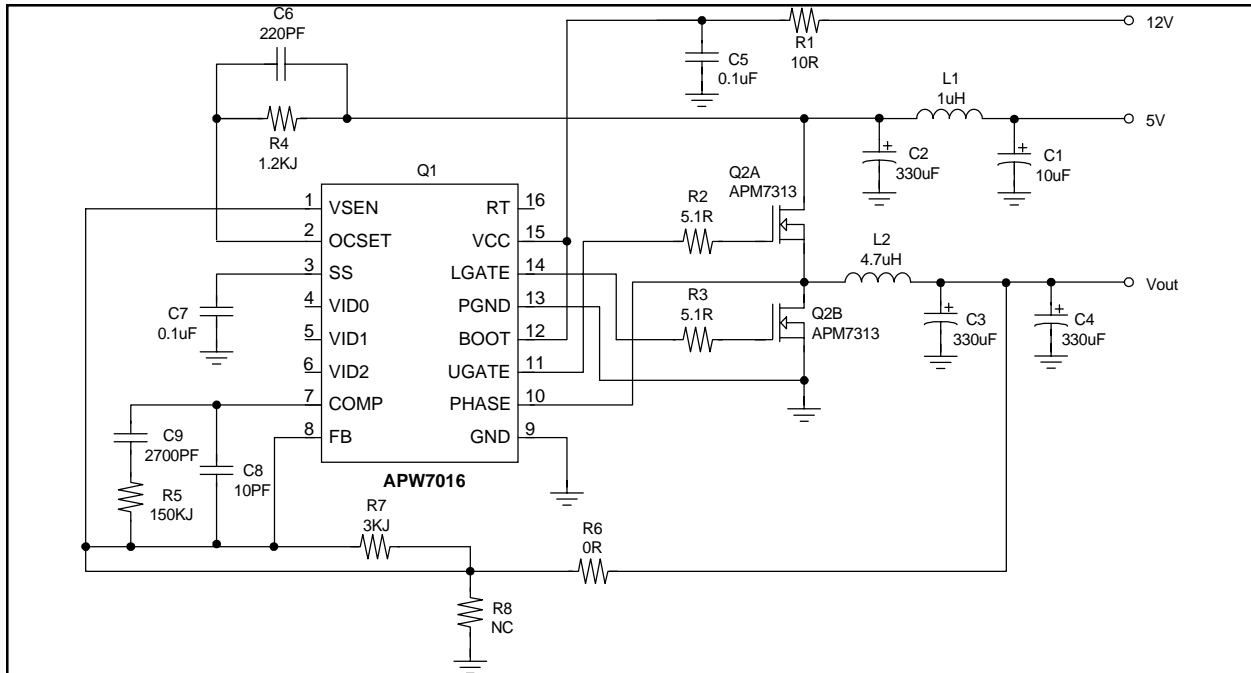
Table 1 Output Voltage Program

| Pin Name | | | Nominal Output Voltage Dacout |
|----------|------|------|-------------------------------|
| VID2 | VID1 | VID0 | |
| 1 | 1 | 1 | 1.3 |
| 1 | 1 | 0 | 1.35 |
| 1 | 0 | 1 | 1.4 |
| 1 | 0 | 0 | 1.45 |
| 0 | 1 | 1 | 1.5 |
| 0 | 1 | 0 | 1.55 |
| 0 | 0 | 1 | 1.6 |
| 0 | 0 | 0 | 1.65 |

Typical Performance Curve

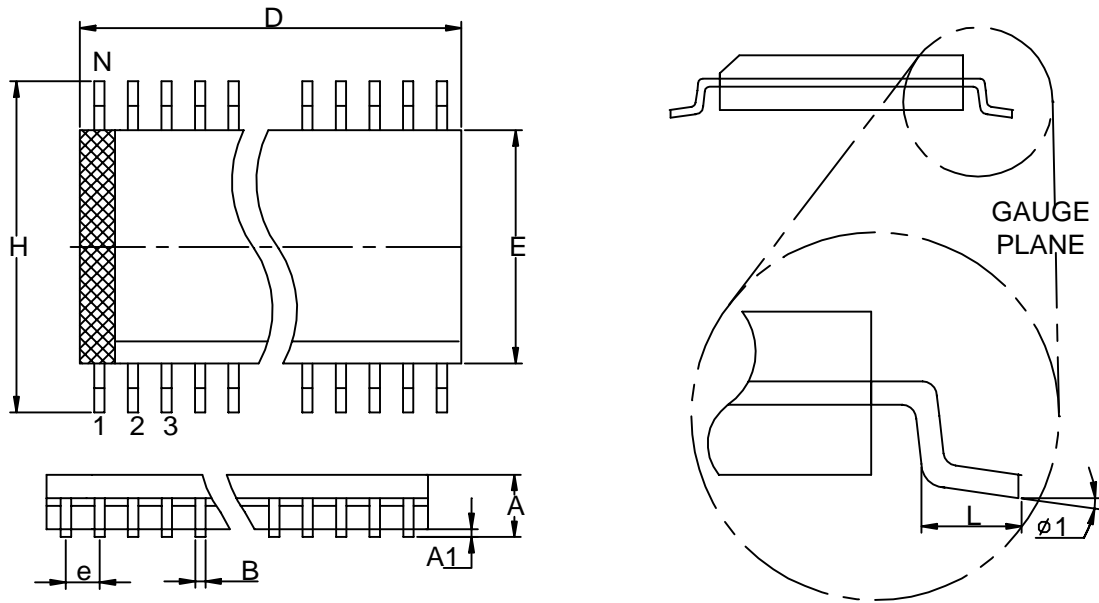


Application Schematic



Package Information

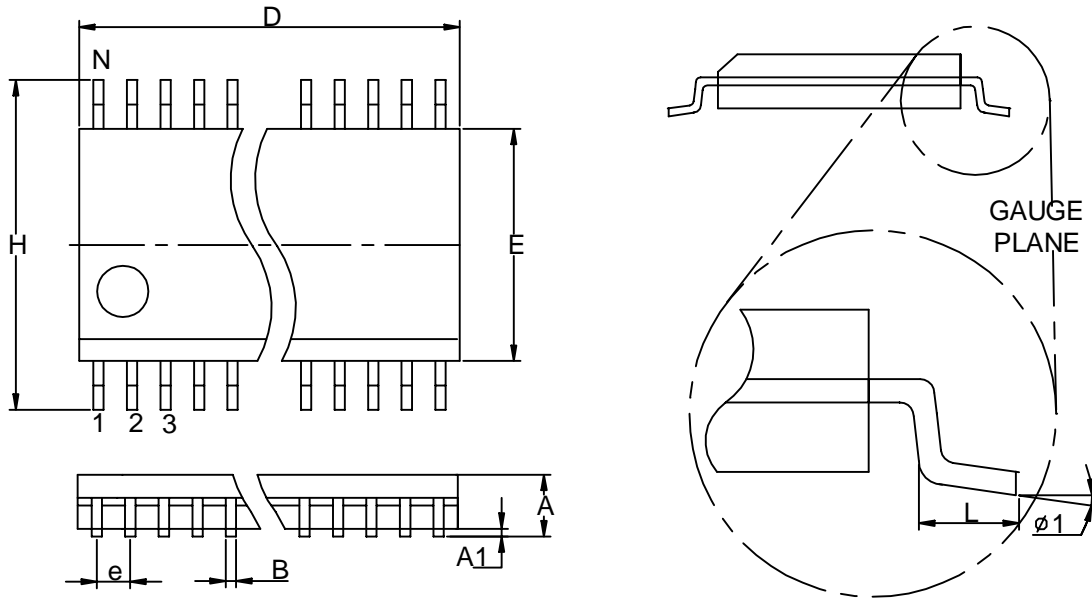
SO – 300mil (Reference JEDEC Registration MS-013)



| Dim | Millimeters | | Variations- D | | | Dim | Inches | | Variations- D | | |
|-------|----------------|-------|---------------|-------|-------|-------|----------------|--------|---------------|-------|-------|
| | Min. | Max. | Variations | Min. | Max. | | Min. | Max. | Variations | Min. | Max. |
| A | 2.35 | 2.65 | SO-16 | 10.10 | 10.50 | A | 0.093 | 0.1043 | SO-16 | 0.398 | 0.413 |
| A1 | 0.10 | 0.30 | SO-18 | 11.35 | 11.76 | A1 | 0.004 | 0.0120 | SO-18 | 0.447 | 0.463 |
| B | 0.33 | 0.51 | SO-20 | 12.60 | 13 | B | 0.013 | 0.020 | SO-20 | 0.496 | 0.512 |
| D | See variations | | SO-24 | 15.20 | 15.60 | D | See variations | | SO-24 | 0.599 | 0.614 |
| E | 7.40 | 7.60 | SO-28 | 17.70 | 18.11 | E | 0.2914 | 0.2992 | SO-28 | 0.697 | 0.713 |
| e | 1.27BSC | | SO-14 | 8.80 | 9.20 | e | 0.050BSC | | SO-14 | 0.347 | 0.362 |
| H | 10 | 10.65 | | | | H | 0.394 | 0.419 | | | |
| L | 0.40 | 1.27 | | | | L | 0.016 | 0.050 | | | |
| N | See variations | | | | | N | See variations | | | | |
| phi 1 | 0° | 8° | | | | phi 1 | 0° | 8° | | | |

Package Information

SSOP-16



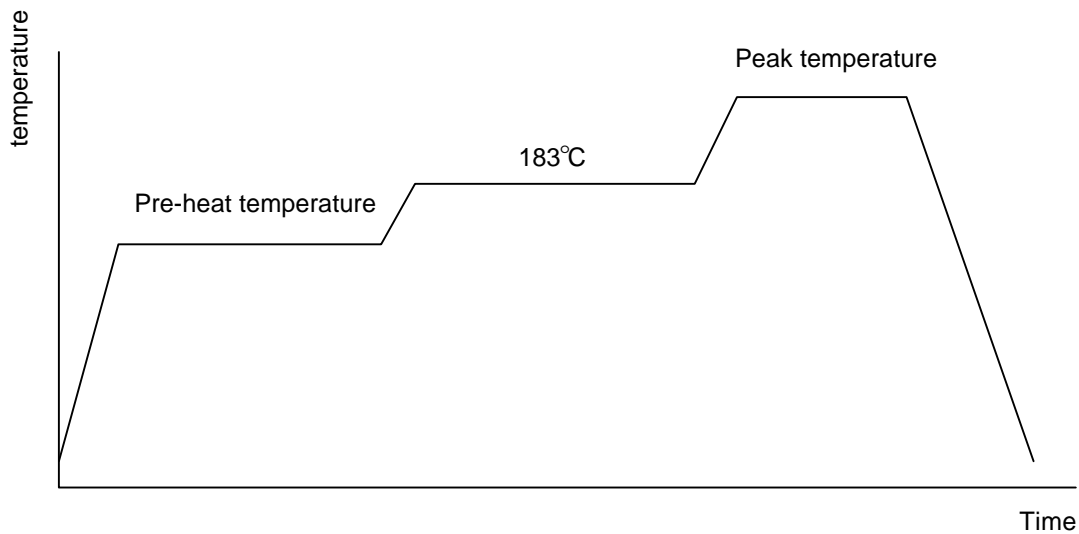
| Dim | Millimeters | | Variations- D | | | Dim | Inches | | Variations- D | | |
|----------|----------------|------|---------------|------|------|----------|----------------|-------|---------------|-------|-------|
| | Min. | Max. | Variations | Min. | Max. | | Min. | Max. | Variations | Min. | Max. |
| A | 1.350 | 1.75 | SSOP-16 | 4.75 | 5.05 | A | 0.053 | 0.069 | SSOP-16 | 0.187 | 0.199 |
| A1 | 0.10 | 0.25 | | | | A1 | 0.004 | 0.010 | | | |
| B | 0.20 | 0.30 | | | | B | 0.008 | 0.012 | | | |
| D | See variations | | | | | D | See variations | | | | |
| E | 3.75 | 4.05 | | | | E | 0.147 | 0.160 | | | |
| e | 0.625 TYP. | | | | | e | 0.025 TYP. | | | | |
| H | 5.75 | 6.25 | | | | H | 0.226 | 0.246 | | | |
| L | 0.4 | 1.27 | | | | L | 0.016 | 0.050 | | | |
| N | See variations | | | | | N | See variations | | | | |
| $\phi 1$ | 0° | 8° | | | | $\phi 1$ | 0° | 8° | | | |

Physical Specifications

| | |
|--------------------|--|
| Terminal Material | Solder-Plated Copper (Solder Material : 90/10 or 63/37 SnPb) |
| Lead Solderability | Meets EIA Specification RSI86-91, ANSI/J-STD-002 Category 3. |

Reflow Condition (IR/Convection or VPR Reflow)

Reference JEDEC Standard J-STD-020A APRIL 1999



Classification Reflow Profiles

| | Convection or IR/ Convection | VPR |
|--|---------------------------------|--------------------------|
| Average ramp-up rate(183°C to Peak) | 3°C/second max. | 10 °C /second max. |
| Preheat temperature (125 ± 25°C) | 120 seconds max | |
| Temperature maintained above 183°C | 60 – 150 seconds | |
| Time within 5°C of actual peak temperature | 10 –20 seconds | 60 seconds |
| Peak temperature range | 220 +5/-0°C or 235 +5/-0°C | 215-219°C or 235 +5/-0°C |
| Ramp-down rate | 6 °C /second max. | 10 °C /second max. |
| Time 25°C to peak temperature | 6 minutes max. | |

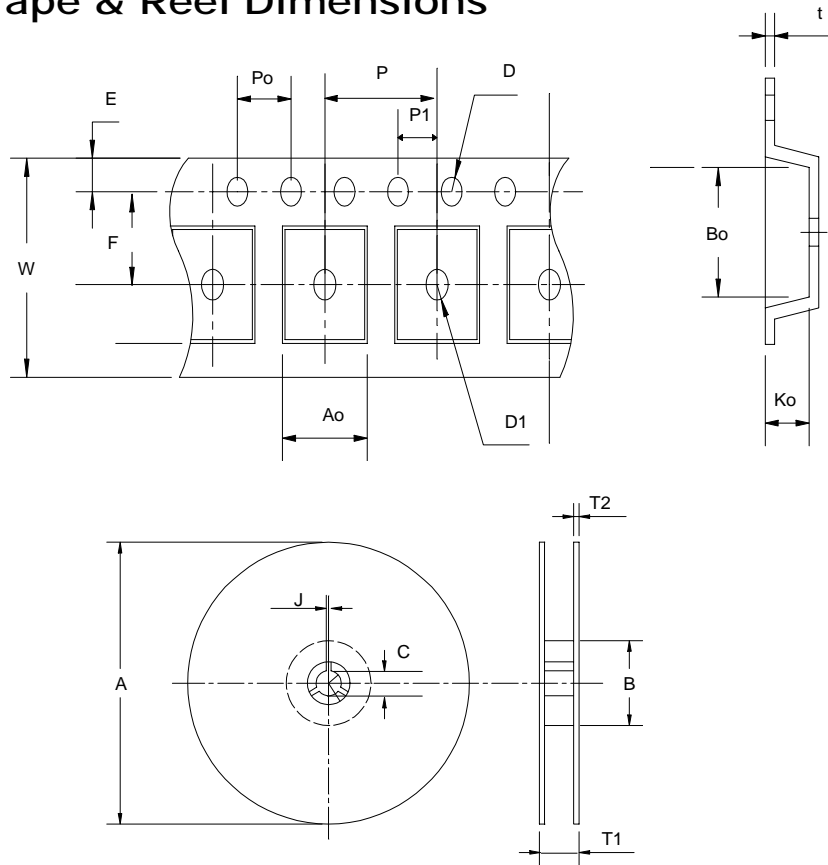
Package Reflow Conditions

| pkg. thickness ≥ 2.5mm and all bgas | pkg. thickness < 2.5mm and pkg. volume ≥ 350 mm ³ | pkg. thickness < 2.5mm and pkg. volume < 350mm ³ |
|--|---|--|
| Convection 220 +5/-0 °C | | Convection 235 +5/-0 °C |
| VPR 215-219 °C | | VPR 235 +5/-0 °C |
| IR/Convection 220 +5/-0 °C | | IR/Convection 235 +5/-0 °C |

Reliability test program

| Test item | Method | Description |
|---------------|---------------------|--------------------------------|
| SOLDERABILITY | MIL-STD-883D-2003 | 245°C , 5 SEC |
| HOLT | MIL-STD-883D-1005.7 | 1000 Hrs Bias @ 125 °C |
| PCT | JESD-22-B, A102 | 168 Hrs, 100 % RH , 121°C |
| TST | MIL-STD-883D-1011.9 | -65°C ~ 150°C, 200 Cycles |
| ESD | MIL-STD-883D-3015.7 | VHBM > 2KV, VMM > 200V |
| Latch-Up | JESD 78 | 10ms , I _{tr} > 100mA |

Carrier Tape & Reel Dimensions



| Application | A | B | C | J | T1 | T2 | W | P | E |
|-------------|----------|----------|-----------|-----------|--------------------------------------|------------|-----------|----------|-----------|
| SOP-16 | 330 ± 1 | 100 +2 | 13+ 0.5 | 2 ± 0.5 | 16.4 ^{+0.3} _{-0.2} | 2.5 ± 0.5 | 16± 0.2 | 12± 0.1 | 1.75±0.1 |
| | F | D | D1 | Po | P1 | Ao | Bo | Ko | t |
| | 7.5± 0.1 | 1.5 +0.1 | 1.5+ 0.25 | 4.0 ± 0.1 | 2.0 ± 0.1 | 10.9 ± 0.1 | 10.8± 0.1 | 3.0± 0.1 | 0.3±0.013 |
| Application | A | B | D0 | D1 | E | F | P0 | P1 | P2 |
| SSOP-16 | 6.95 | 5.4 | 1.55±0.05 | 1.55±0.1 | 1.75±0.1 | 5.5±0.05 | 4.0±0.1 | 8.0±0.1 | 2.0±0.05 |
| | T | T2 | W | W1 | C1 | C2 | T1 | T2 | C |
| | 0.3±0.05 | 2.2 | 12.0±0.3 | 9.5 | 13±0.3 | 21±0.8 | 13.5±0.5 | 2.0±0.2 | 80±1 |

Cover Tape Dimensions

| Application | Carrier Width | Cover Tape Width | Devices Per Reel |
|-------------|---------------|------------------|------------------|
| SOP- 16 | 24 | 21.3 | 1000 |

Customer Service

Anpec Electronics Corp.

Head Office :

5F, No. 2 Li-Hsin Road, SBIP,

Hsin-Chu, Taiwan, R.O.C.

Tel : 886-3-5642000

Fax : 886-3-5642050

Taipei Branch :

7F, No. 137, Lane 235, Pac Chiao Rd.,

Hsin Tien City, Taipei Hsien, Taiwan, R. O. C.

Tel : 886-2-89191368

Fax : 886-2-89191369